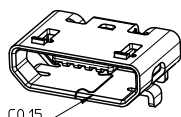
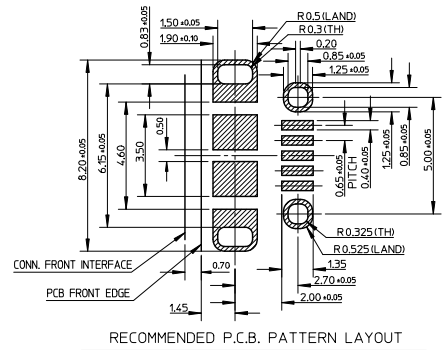


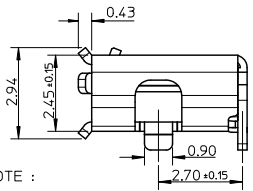
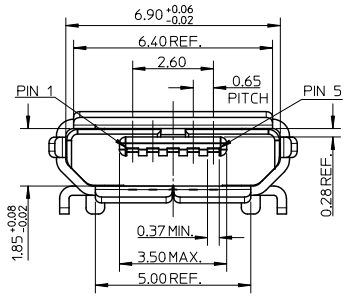
WITH FLANGE
105017-0001
MATTE TIN 2.0 MICRON



WITHOUT FLANGE
105017-1001
MATTE TIN 3.8 MICRON

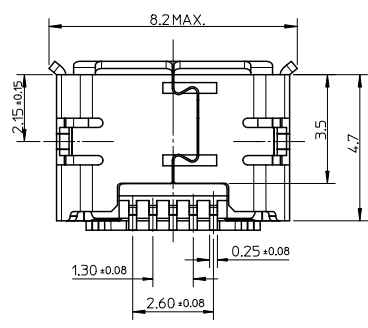
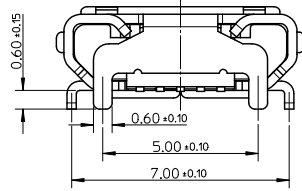


RECOMMENDED P.C.B. PATTERN LAYOUT



NOTE :

- MATERIAL :
HOUSING : LCP, BLACK, UL94V-0
TERMINAL : COPPER ALLOY THICKNESS = 0.15 MM
SHIELD CASE : STAINLESS STEEL THICKNESS = 0.30 MM
- PLATING :
TERMINAL: CONTACT AREA : GOLD FLASH OVER MINIMUM 0.75 MICRON Pd/Ni.
SOLDER TAIL AREA : GOLD FLASH.
UNDER PLATING : NICKEL 2.0 MICRON MINIMUM.
SHIELD : MATTE TIN
UNDER PLATING : NICKEL 1.27 MICRON MINIMUM.
- TAIL & NAIL COPLANARITY 0.08 mm MAXIMUM.
- PRODUCT SPEC.: PS-105017-001, PACKAGE SPEC.: PK-105017-001
- COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV DIRECTIVE 2000/53/EC.



ADD PART NUMBER EC NO: SH2011-0212 DRAWN BY: XJSONG CHKD: APPR: RZHANG DATE: 2011/02/14 DATE: 2011/02/16	DESCRIPTION DESCRIPTION	QUALITY SYMBOLS $\nabla=0$ $\nabla=0$ $\nabla=0$	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY	DATE	TITLE		
				4 PLACES ± --- ± ---	3 PLACES ± --- ± ---	XJSONG	2008/01/23	MICRO USB B REC. BOTTOM MOUNT WITH THROUGH HOLE TYPE		
				2 PLACES ± 0.25 ± ---	1 PLACE ± 0.25 ± ---	JTIAN	2008/01/23	MOLEX INCORPORATED		
		ANGULAR ± 3°		APPROVED BY	DATE	DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		HWANG	2008/01/23	105017-001		SD-105017-001		
				MATERIAL NO.			1 OF 1			
				MATERIAL NO.			1 OF 1			